

## HFB1N70S

### 700V N-Channel MOSFET

#### FEATURES

- Originative New Design
- Superior Avalanche Rugged Technology
- Robust Gate Oxide Technology
- Very Low Intrinsic Capacitances
- Excellent Switching Characteristics
- Unrivalled Gate Charge : 4.5 nC (Typ.)
- Extended Safe Operating Area
- Lower  $R_{DS(ON)}$  : 14  $\Omega$  (Typ.) @  $V_{GS}=10V$
- 100% Avalanche Tested

$$BV_{DSS} = 700 \text{ V}$$

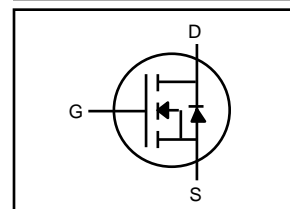
$$R_{DS(on) \text{ typ}} = 14.0 \ \Omega$$

$$I_D = 0.3 \text{ A}$$

TO-92



1.Gate 2. Drain 3. Source



#### Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Value	Units
$V_{DSS}$	Drain-Source Voltage	700	V
$I_D$	Drain Current – Continuous ( $T_C = 25^\circ\text{C}$ )	0.3	A
	Drain Current – Continuous ( $T_C = 100^\circ\text{C}$ )	0.18	A
$I_{DM}$	Drain Current – Pulsed (Note 1)	1.2	A
$V_{GS}$	Gate-Source Voltage	$\pm 30$	V
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	33	mJ
$I_{AR}$	Avalanche Current (Note 1)	0.3	A
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	0.25	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.5	V/ns
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ )	2.5	W
	– Derate above $25^\circ\text{C}$	0.02	W/ $^\circ\text{C}$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	$^\circ\text{C}$

\* Drain current limited by junction temperature

#### Thermal Resistance Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JL}$	Junction-to-Lead	--	50	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Junction-to-Ambient	--	140	

**Electrical Characteristics**  $T_C=25\text{ }^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>On Characteristics</b>						
$V_{GS}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	2.5	--	4.5	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\ \text{V}, I_D = 0.15\ \text{A}$	--	14	17.5	$\Omega$
<b>Off Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\ \text{V}, I_D = 250\ \mu\text{A}$	700	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\ \mu\text{A}$ , Referenced to $25\text{ }^\circ\text{C}$	--	0.65	--	$\text{V}/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 700\ \text{V}, V_{GS} = 0\ \text{V}$	--	--	1	$\mu\text{A}$
		$V_{DS} = 560\ \text{V}, T_C = 125\text{ }^\circ\text{C}$	--	--	10	$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage Current, Forward	$V_{GS} = 30\ \text{V}, V_{DS} = 0\ \text{V}$	--	--	100	nA
$I_{GSSR}$	Gate-Body Leakage Current, Reverse	$V_{GS} = -30\ \text{V}, V_{DS} = 0\ \text{V}$	--	--	-100	nA
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS} = 25\ \text{V}, V_{GS} = 0\ \text{V},$ $f = 1.0\ \text{MHz}$	--	--	175	pF
$C_{oss}$	Output Capacitance		--	--	30	pF
$C_{rss}$	Reverse Transfer Capacitance		--	--	5	pF
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Time	$V_{DS} = 350\ \text{V}, I_D = 0.8\ \text{A},$ $R_G = 25\ \Omega$  (Note 4,5)	--	12	30	ns
$t_r$	Turn-On Rise Time		--	40	140	ns
$t_{d(off)}$	Turn-Off Delay Time		--	20	60	ns
$t_f$	Turn-Off Fall Time		--	30	80	ns
$Q_g$	Total Gate Charge	$V_{DS} = 560\ \text{V}, I_D = 0.8\ \text{A},$ $V_{GS} = 10\ \text{V}$  (Note 4,5)	--	--	6.0	nC
$Q_{gs}$	Gate-Source Charge		--	--	--	nC
$Q_{gd}$	Gate-Drain Charge		--	--	--	nC
<b>Source-Drain Diode Maximum Ratings and Characteristics</b>						
$I_S$	Continuous Source-Drain Diode Forward Current		--	--	0.3	A
$I_{SM}$	Pulsed Source-Drain Diode Forward Current		--	--	1.2	
$V_{SD}$	Source-Drain Diode Forward Voltage	$I_S = 0.3\ \text{A}, V_{GS} = 0\ \text{V}$	--	--	1.4	V
$t_{rr}$	Reverse Recovery Time	$I_S = 0.8\ \text{A}, V_{GS} = 0\ \text{V}$ $di_F/dt = 100\ \text{A}/\mu\text{s}$ (Note 4)	--	190	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	0.53	--	$\mu\text{C}$

**Notes ;**

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2.  $L=96\text{mH}, I_{AS}=0.8\text{A}, V_{DD}=50\text{V}, R_G=25\Omega$ , Starting  $T_J=25\text{ }^\circ\text{C}$
3.  $I_{SD} \leq 0.3\text{A}, di/dt \leq 200\text{A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$ , Starting  $T_J=25\text{ }^\circ\text{C}$
4. Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$
5. Essentially Independent of Operating Temperature